# PSMN3R0-60PS

## N-channel 60 V 3.0 mΩ standard level MOSFET

Rev. 02 — 28 October 2010 Product data sheet

## 1. Product profile

### 1.1 General description

Standard level N-channel MOSFET in a TO220 package qualified to 175 °C. This product is designed and qualified for use in a wide range of industrial, communications and domestic equipment.

### 1.2 Features and benefits

- High efficiency due to low switching and conduction losses
- Suitable for standard level gate drive sources

### 1.3 Applications

- DC-to-DC converters
- Load switching
- Motor control
- Server power supplies

### 1.4 Quick reference data

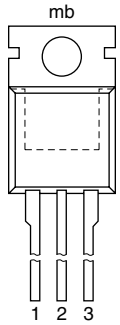
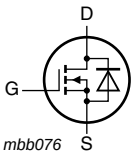
**Table 1. Quick reference data**

| Symbol | Parameter | Conditions | | Min | Typ | Max | Unit |
|---|---|---|---|---|---|---|---|
| $V_{DS}$ | drain-source voltage | $T_j \geq 25$ °C; $T_j \leq 175$ °C | | - | - | 60 | V |
| $I_D$ | drain current | $T_{mb} = 25$ °C; $V_{GS} = 10$ V; see Figure 1 | [1] | - | - | 100 | A |
| $P_{tot}$ | total power dissipation | $T_{mb} = 25$ °C; see Figure 2 | | - | - | 306 | W |
| **Static characteristics** | | | | | | | |
| $R_{DSon}$ | drain-source on-state resistance | $V_{GS} = 10$ V; $I_D = 25$ A; $T_j = 25$ °C; see Figure 11; see Figure 12 | | - | 2.4 | 3 | mΩ |
| **Dynamic characteristics** | | | | | | | |
| $Q_{GD}$ | gate-drain charge | $V_{GS} = 10$ V; $I_D = 80$ A; $V_{DS} = 12$ V; see Figure 13; see Figure 14 | | - | 28 | - | nC |
| **Avalanche ruggedness** | | | | | | | |
| $E_{DS(AL)S}$ | non-repetitive drain-source avalanche energy | $V_{GS} = 10$ V; $T_{j(init)} = 25$ °C; $I_D = 100$ A; $V_{sup} \leq 60$ V; $R_{GS} = 50$ Ω; unclamped | | - | - | 800 | mJ |

[1] Continuous current is limited by package.

## 2. Pinning information

**Table 2. Pinning information**

| Pin | Symbol | Description | Simplified outline | Graphic symbol |
|---|---|---|---|---|
| 1 | G | gate |  |  |
| 2 | D | drain | | |
| 3 | S | source | | |
| mb | D | mounting base; connected to drain | | |



**SOT78 (TO-220AB)**

## 3. Ordering information

**Table 3. Ordering information**

| Type number | Package | | |
|---|---|---|---|
| | Name | Description | Version |
| PSMN3R0-60PS | TO-220AB | plastic single-ended package; heatsink mounted; 1 mounting hole; 3-lead TO-220AB | SOT78 |

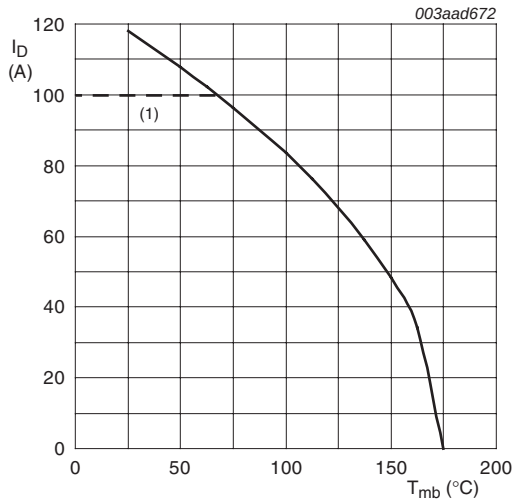
## 4. Limiting values

**Table 4. Limiting values**

*In accordance with the Absolute Maximum Rating System (IEC 60134).*

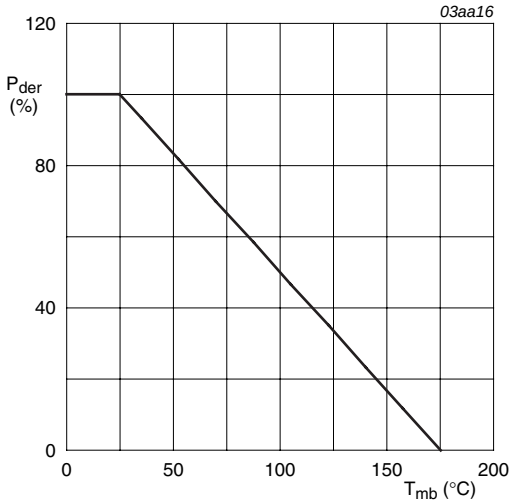
| Symbol | Parameter | Conditions | | Min | Max | Unit |
|---|---|---|---|---|---|---|
| $V_{DS}$ | drain-source voltage | $T_j \geq 25$ °C; $T_j \leq 175$ °C | | - | 60 | V |
| $V_{DGR}$ | drain-gate voltage | $T_j \geq 25$ °C; $T_j \leq 175$ °C; $R_{GS}$ = 20 kΩ | | - | 60 | V |
| $V_{GS}$ | gate-source voltage | | | -20 | 20 | V |
| $I_D$ | drain current | $V_{GS}$ = 10 V; $T_{mb}$ = 100 °C; see Figure 1 | | - | 83.4 | A |
| | | $V_{GS}$ = 10 V; $T_{mb}$ = 25 °C; see Figure 1 | [1] | - | 100 | A |
| $I_{DM}$ | peak drain current | pulsed; $t_p \leq 10$ µs; $T_{mb}$ = 25 °C; see Figure 3 | | - | 824 | A |
| $P_{tot}$ | total power dissipation | $T_{mb}$ = 25 °C; see Figure 2 | | - | 306 | W |
| $T_{stg}$ | storage temperature | | | -55 | 175 | °C |
| $T_j$ | junction temperature | | | -55 | 175 | °C |
| **Source-drain diode** | | | | | | |
| $I_S$ | source current | $T_{mb}$ = 25 °C | [1] | - | 100 | A |
| $I_{SM}$ | peak source current | pulsed; $t_p \leq 10$ µs; $T_{mb}$ = 25 °C | | - | 824 | A |
| **Avalanche ruggedness** | | | | | | |
| $E_{DS(AL)S}$ | non-repetitive drain-source avalanche energy | $V_{GS}$ = 10 V; $T_{j(init)}$ = 25 °C; $I_D$ = 100 A; $V_{sup} \leq 60$ V; $R_{GS}$ = 50 Ω; unclamped | | - | 800 | mJ |

[1] Continuous current is limited by package.



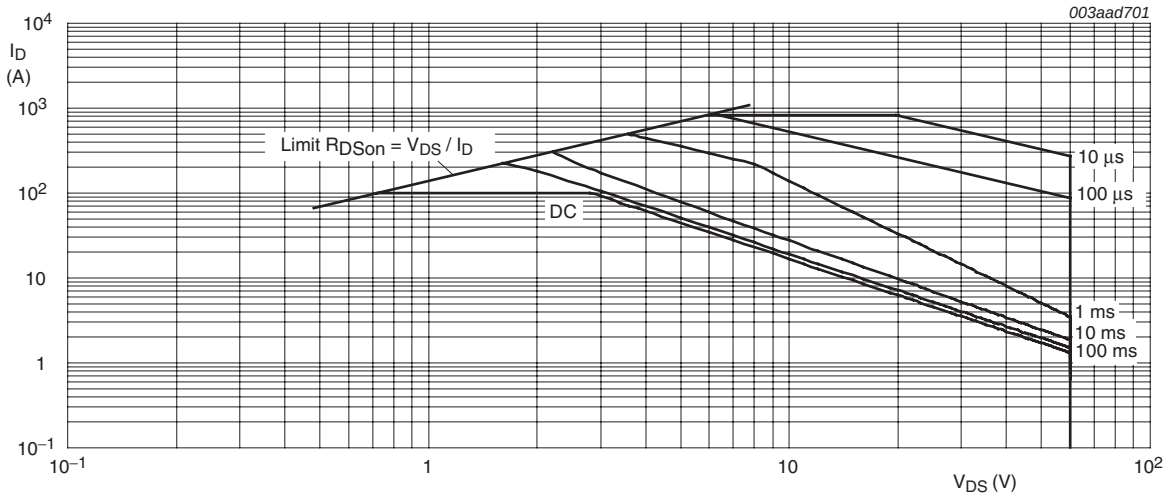

$V_{GS} \geq 10$ V(1) Capped at 100 A due to package

**Fig 1. Continuous drain current as a function of mounting base temperature.**




$$P_{der} = \frac{P_{tot}}{P_{tot(25°C)}} \times 100\ \%$$

**Fig 2. Normalized total power dissipation as a function of mounting base temperature**




$T_{mb} = 25$ °C; $I_{DM}$ is a single pulse; Capped at 100 A due to package

**Fig 3. Safe operating area; continuous and peak drain currents as a function of drain-source voltage**

## 5. Thermal characteristics

**Table 5. Thermal characteristics**

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|---|---|---|---|---|---|---|
| $R_{th(j\text{-}mb)}$ | thermal resistance from junction to mounting base | see Figure 4 | - | 0.3 | 0.49 | K/W |

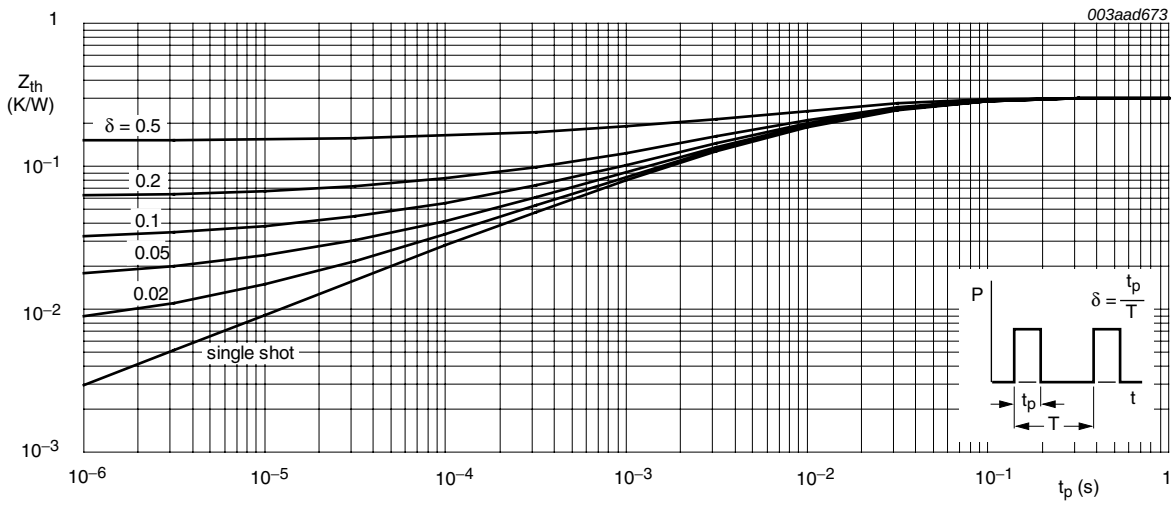
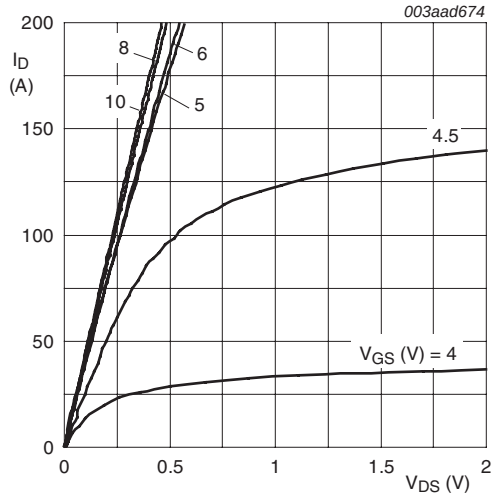



**Fig 4. Transient thermal impedance from junction to mounting base as a function of pulse duration**

# 6. Characteristics

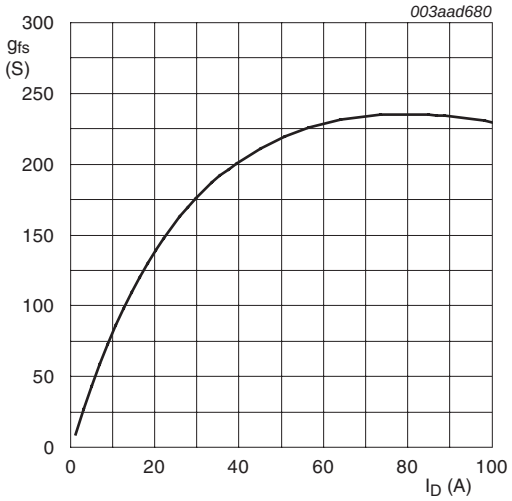
**Table 6. Characteristics**

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|---|---|---|---|---|---|---|
| **Static characteristics** | | | | | | |
| $V_{(BR)DSS}$ | drain-source breakdown voltage | $I_D$ = 250 µA; $V_{GS}$ = 0 V; $T_j$ = -55 °C | 54 | - | - | V |
| | | $I_D$ = 250 µA; $V_{GS}$ = 0 V; $T_j$ = 25 °C | 60 | - | - | V |
| $V_{GS(th)}$ | gate-source threshold voltage | $I_D$ = 1 mA; $V_{DS}$ = $V_{GS}$; $T_j$ = 25 °C; see Figure 8; see Figure 9 | 2 | 3 | 4 | V |
| $V_{GSth}$ | gate-source threshold voltage | $I_D$ = 1 mA; $V_{DS}$ = $V_{GS}$; $T_j$ = 175 °C; see Figure 9 | 1 | - | - | V |
| | | $I_D$ = 1 mA; $V_{DS}$ = $V_{GS}$; $T_j$ = -55 °C; see Figure 9 | - | - | 4.6 | V |
| $I_{DSS}$ | drain leakage current | $V_{DS}$ = 60 V; $V_{GS}$ = 0 V; $T_j$ = 25 °C | - | 0.05 | 10 | µA |
| | | $V_{DS}$ = 60 V; $V_{GS}$ = 0 V; $T_j$ = 175 °C | - | - | 500 | µA |
| $I_{GSS}$ | gate leakage current | $V_{GS}$ = -20 V; $V_{DS}$ = 0 V; $T_j$ = 25 °C | - | 2 | 100 | nA |
| | | $V_{GS}$ = 20 V; $V_{DS}$ = 0 V; $T_j$ = 25 °C | - | 2 | 100 | nA |
| $R_{DSon}$ | drain-source on-state resistance | $V_{GS}$ = 10 V; $I_D$ = 25 A; $T_j$ = 175 °C; see Figure 10 | - | - | 7.2 | mΩ |
| | | $V_{GS}$ = 10 V; $I_D$ = 25 A; $T_j$ = 25 °C; see Figure 11; see Figure 12 | - | 2.4 | 3 | mΩ |
| $R_G$ | gate resistance | f = 1 MHz | - | 1.1 | - | Ω |
| **Dynamic characteristics** | | | | | | |
| $Q_{G(tot)}$ | total gate charge | $I_D$ = 80 A; $V_{DS}$ = 12 V; $V_{GS}$ = 10 V; see Figure 13; see Figure 14 | - | 130 | - | nC |
| $Q_{GS}$ | gate-source charge | $I_D$ = 80 A; $V_{DS}$ = 12 V; $V_{GS}$ = 10 V; see Figure 14; see Figure 13 | - | 43 | - | nC |
| $Q_{GD}$ | gate-drain charge | $I_D$ = 80 A; $V_{DS}$ = 12 V; $V_{GS}$ = 10 V; see Figure 13; see Figure 14 | - | 28 | - | nC |
| $C_{iss}$ | input capacitance | $V_{DS}$ = 30 V; $V_{GS}$ = 0 V; f = 1 MHz; $T_j$ = 25 °C; see Figure 15; see Figure 16 | - | 8079 | - | pF |
| $C_{oss}$ | output capacitance | $V_{DS}$ = 30 V; $V_{GS}$ = 0 V; f = 1 MHz; $T_j$ = 25 °C; see Figure 15 | - | 971 | - | pF |
| $C_{rss}$ | reverse transfer capacitance | $V_{DS}$ = 30 V; $V_{GS}$ = 0 V; f = 1 MHz; $T_j$ = 25 °C; see Figure 15; see Figure 16 | - | 492 | - | pF |
| $t_{d(on)}$ | turn-on delay time | $V_{DS}$ = 30 V; $R_L$ = 0.5 Ω; $V_{GS}$ = 10 V; $R_{G(ext)}$ = 1.5 Ω | - | 31 | - | ns |
| $t_r$ | rise time | | - | 26 | - | ns |
| $t_{d(off)}$ | turn-off delay time | | - | 77 | - | ns |
| $t_f$ | fall time | | - | 22 | - | ns |
| **Source-drain diode** | | | | | | |
| $V_{SD}$ | source-drain voltage | $I_S$ = 25 A; $V_{GS}$ = 0 V; $T_j$ = 25 °C; see Figure 17 | - | 0.88 | 1.2 | V |
| $t_{rr}$ | reverse recovery time | $I_S$ = 25 A; $dI_S/dt$ = -100 A/µs; $V_{GS}$ = 0 V; $V_{DS}$ = 30 V | - | 54 | - | ns |
| $Q_r$ | recovered charge | | - | 97 | - | nC |



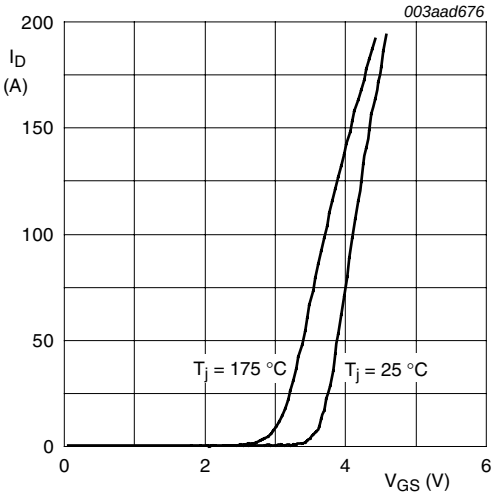

$T_j = 25\ °C;\ t_p = 300\mu s$

**Fig 5. Output characteristics: drain current as a function of drain-source voltage; typical values**



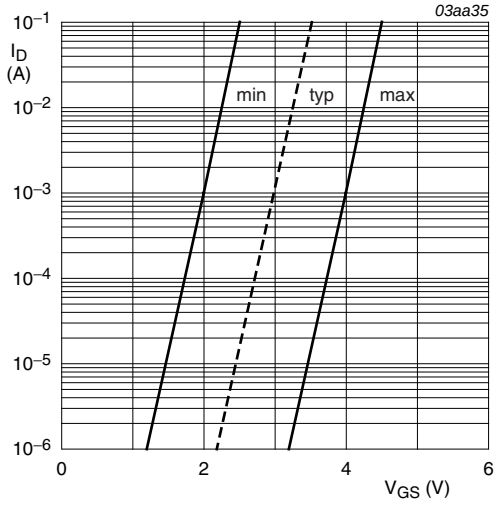

$T_j = 25\ °C;\ V_{DS} = 30V$

**Fig 6. Forward transconductance as a function of drain current; typical values**



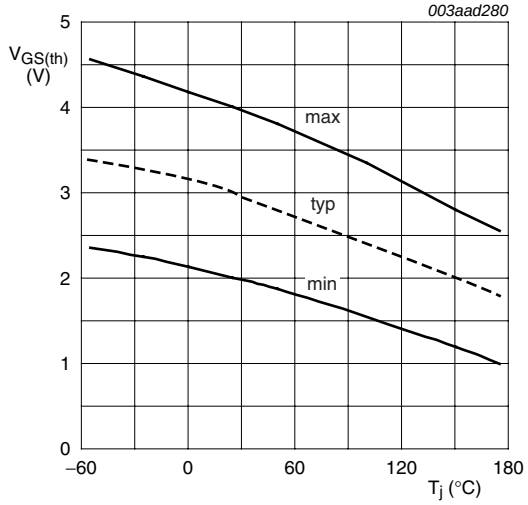

$V_{DS} = 30\ V$

**Fig 7. Transfer characteristics: drain current as a function of gate-source voltage; typical values**



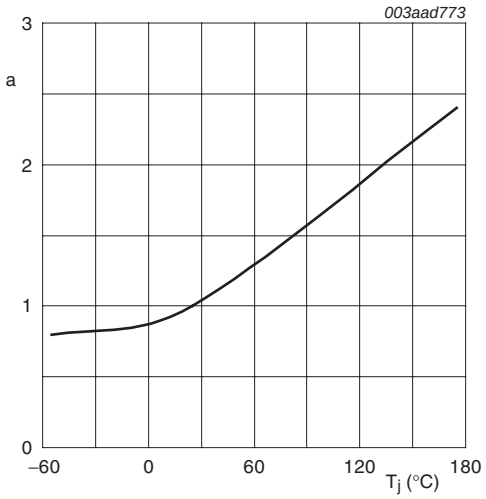

$T_j = 25\ °C; V_{DS} = 5V$

**Fig 8. Sub-threshold drain current as a function of gate-source voltage**



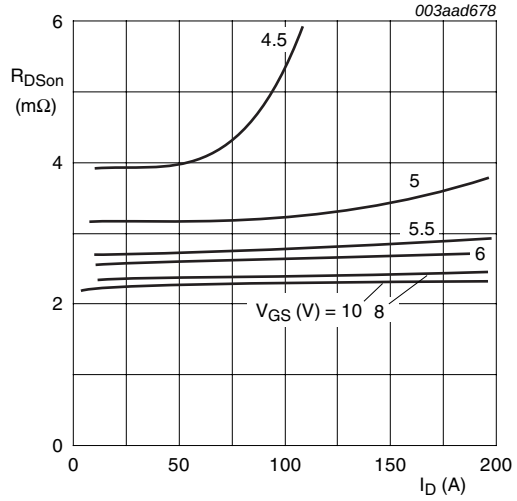

$I_D = 1\ \text{mA};\ V_{DS} = V_{GS}$

**Fig 9. Gate-source threshold voltage as a function of junction temperature**



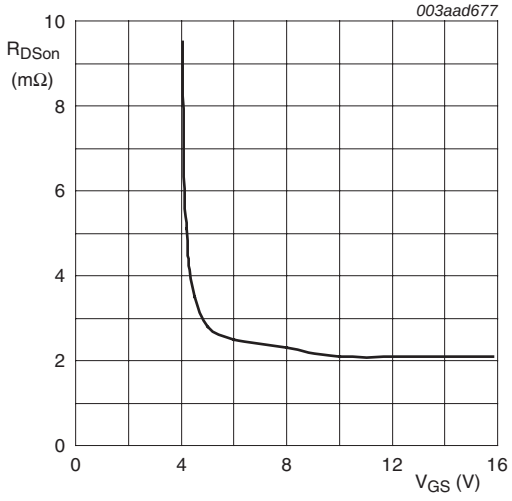

$$a = \frac{R_{DSon}}{R_{DSon(25\,°C)}}$$

**Fig 10. Normalized drain-source on-state resistance factor as a function of junction temperature**



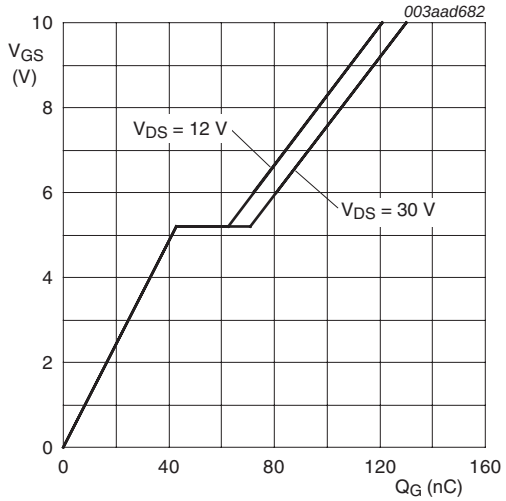

$T_j = 25\ °C;\ t_p = 300\ \mu s$

**Fig 11. Drain-source on-state resistance as a function of drain current; typical values**




$T_j = 25\ °C;\ I_D = 25\ \text{A}$

**Fig 12. Drain-source on-state resistance as a function of gate-source voltage; typical values**




$T_j = 25\ °C; I_D = 80\ A$

**Fig 13. Gate-source voltage as a function of gate charge; typical values**

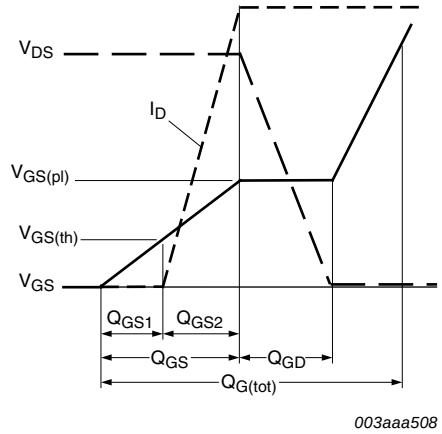
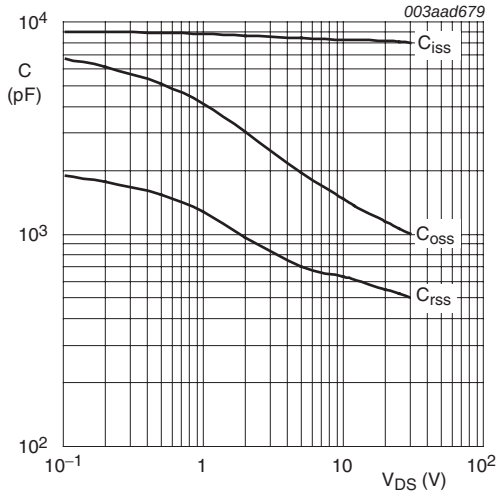
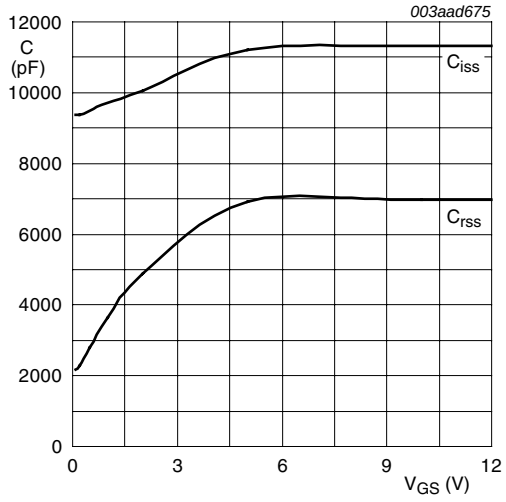



**Fig 14. Gate charge waveform definitions**



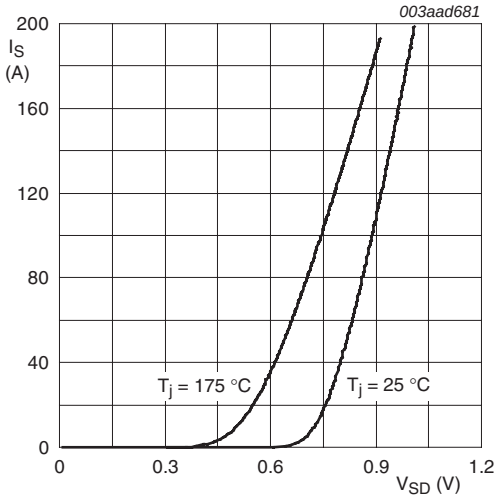

$V_{GS} = 0\ V; f = 1\ MHz$

**Fig 15. Input, output and reverse transfer capacitances as a function of drain-source voltage; typical values**




$f = 1\ MHz$

**Fig 16. Input and reverse transfer capacitances as a function of gate-source voltage, typical values**

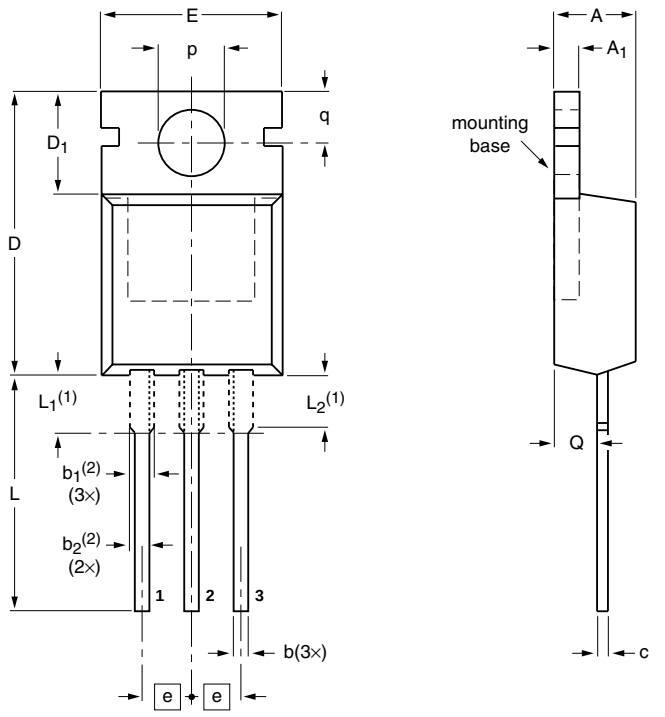



$V_{GS} = 0$ V

**Fig 17. Source (diode forward) current as a function of source-drain (diode forward) voltage; typical values**

# 7. Package outline

**Plastic single-ended package; heatsink mounted; 1 mounting hole; 3-lead TO-220AB** **SOT78**




**DIMENSIONS (mm are the original dimensions)**

| UNIT | A | $A_1$ | b | $b_1$(2) | $b_2$(2) | c | D | $D_1$ | E | e | L | $L_1$(1) | $L_2$(1) max. | p | q | Q |
|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| mm | 4.7<br>4.1 | 1.40<br>1.25 | 0.9<br>0.6 | 1.6<br>1.0 | 1.3<br>1.0 | 0.7<br>0.4 | 16.0<br>15.2 | 6.6<br>5.9 | 10.3<br>9.7 | 2.54 | 15.0<br>12.8 | 3.30<br>2.79 | 3.0 | 3.8<br>3.5 | 3.0<br>2.7 | 2.6<br>2.2 |

**Notes**
1. Lead shoulder designs may vary.
2. Dimension includes excess dambar.

| OUTLINE VERSION | REFERENCES | | | | EUROPEAN PROJECTION | ISSUE DATE |
|---|---|---|---|---|---|---|
| | IEC | JEDEC | JEITA | | | |
| SOT78 | | 3-lead TO-220AB | SC-46 | | | ~~08-04-23~~<br>08-06-13 |

**Fig 18. Package outline SOT78 (TO-220AB)**

# 8. Revision history

**Table 7. Revision history**

| Document ID | Release date | Data sheet status | Change notice | Supersedes |
|---|---|---|---|---|
| PSMN3R0-60PS v.2 | 20101028 | Product data sheet | - | PSMN3R0-60PS v.1 |
| Modifications: | • Various changes to content. | | | |
| PSMN3R0-60PS v.1 | 20091123 | Product data sheet | - | - |

# 9. Legal information

## 9.1 Data sheet status

| Document status[1][2] | Product status[3] | Definition |
|---|---|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nexperia.com.

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## 10. Contact information

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